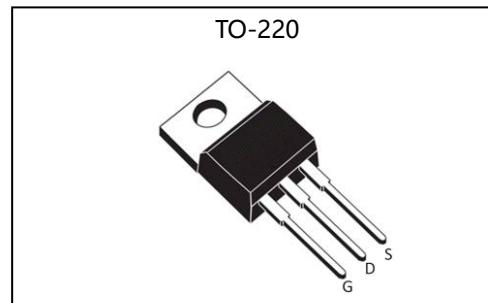


Silicon N-Channel Power MOSFET
General Description:

The HMB250N06 uses advanced trench technology and design to provide excellent RDS(ON) with low gate charge. It can be used in a wide variety of applications. The package form is TO-220, which accords with the RoHS standard.

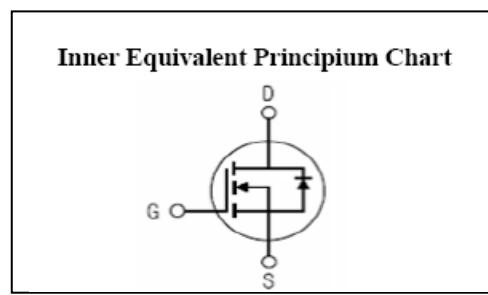
V_{DSS}	60	V
I_D	250	A
P_D	350	W
$R_{DS(ON)type}$	1.9	$m\Omega$


Features:

- Fast Switching
- Low Gate Charge and Rdson
- Low Reverse transfer capacitances
- 100% Single Pulse avalanche energy Test

Applications:

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply


Absolute (Tc=25°C unless otherwise specified):

Symbol	Parameter	Rating	Units
V_{DSS}	Drain-to-Source Voltage	60	V
I_D	Continuous Drain Current	250	A
	Continuous Drain Current $T_c = 100 \text{ } ^\circ\text{C}$	160	A
I_{DM}	Pulsed Drain Current	800	A
V_{GS}	Gate-to-Source Voltage	± 20	V
E_{AS}^{a2}	Single Pulse Avalanche Energy	600	μJ
E_{AR}^{a1}	Avalanche Energy ,Repetitive	80	μJ
I_{AR}^{a1}	Avalanche Current	130	A
dv/dt^{a3}	Peak Diode Recovery dv/dt	5.0	V/ns
P_D	Power Dissipation	350	W
T_J, T_{stg}	Operating Junction and Storage Temperature Range	175, -55 to 175	$^\circ\text{C}$
T_L	Maximum Temperature for Soldering	300	$^\circ\text{C}$

Electrical Characteristics (Tc=25°C unless otherwise specified):

OFF Characteristics						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
V _{DSS}	Drain to Source Breakdown Voltage	V _{GS} =0V, I _D =250μA	60	--	--	V
ΔBV _{DSS} /ΔT _J	Bvdss Temperature Coefficient	I _D =250uA, Reference 25°C	--	0.1	--	V/°C
I _{DSS}	Drain to Source Leakage Current	V _{DS} =60V, V _{GS} = 0V, T _a =25°C	--	--	1	μA
		V _{DS} =48V, V _{GS} =0V, T _a =125°C	--	--	250	
I _{GSS(F)}	Gate to Source Forward Leakage	V _{GS} =+20V	--	--	1	μA
I _{GSS(R)}	Gate to Source Reverse Leakage	V _{GS} =-20V	--	--	-1	μA

ON Characteristics						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
R _{DSON}	Drain-to-Source On-Resistance	V _{GS} =10V, I _D =800A	--	1.9	2.5	mΩ
R _{DSON}	Drain-to-Source On-Resistance	V _{GS} =5V, I _D =40A	--	2.4	2.9	mΩ
V _{GS(TH)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250μA	1.0	--	3.0	V
Pulse width tp≤380μs, δ≤2%						

Dynamic Characteristics						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
g _{fs}	Forward Transconductance	V _{DS} =5V, I _D =50A	70	--	--	S
C _{iss}	Input Capacitance		--	12000	--	pF
C _{oss}	Output Capacitance	V _{GS} =0V, V _{DS} =30V f=1.0MHz	--	1400	--	
C _{rss}	Reverse Transfer Capacitance		--	80	--	

Resistive Switching Characteristics						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
t _{d(ON)}	Turn-on Delay Time	I _D =60A, V _{DD} =30V V _{GS} =10V, R _G =2.5Ω	--	26	--	ns
t _r	Rise Time		--	25	--	
t _{d(OFF)}	Turn-Off Delay Time		--	88	--	
t _f	Fall Time		--	36	--	
Q _g	Total Gate Charge	I _D =60A, V _{DD} =30V V _{GS} =10V	--	150	--	nC
Q _{gs}	Gate to Source Charge		--	42	--	
Q _{gd}	Gate to Drain ("Miller")Charge		--	19	--	

Source-Drain Diode Characteristics

Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
I_S	Continuous Source Current (Body Diode)		--	--	250	A
I_{SM}	Maximum Pulsed Current (Body Diode)		--	--	800	A
V_{SD}	Diode Forward Voltage	$I_S=100A, V_{GS}=0V$	--	--	1.5	V
t_{rr}	Reverse Recovery Time	$I_S=100A, T_j=25^\circ C$	--	90	--	ns
Q_{rr}	Reverse Recovery Charge	$dI_F/dt=100A/\mu s, V_{GS}=0V$	--	150	--	nC

 Pulse width $t_p \leq 380\mu s, \delta \leq 2\%$

Symbol	Parameter	Typ.	Units
$R_{\theta c}$	Junction-to-Case	0.41	°C/W

^{a1}: Repetitive rating; pulse width limited by maximum junction temperature

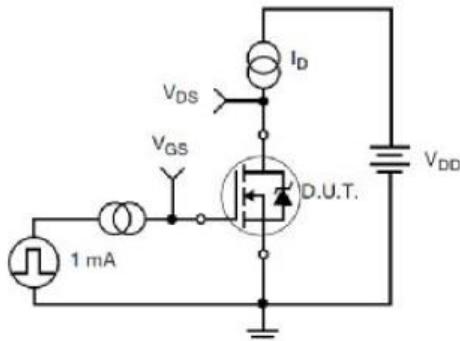
^{a2}: EAS condition: $T_j=25^\circ C, V_{DD}=30V, V_G=10V, L=0.5mH, R_g=25\Omega$
^{a3}: $I_{SD} = 100A, dI/dt \leq 100A/\mu s, V_{DD} \leq BV_{DS}$, Start $T_j=25^\circ C$
Test Circuit and Waveform


Figure 17. Gate Charge Test Circuit

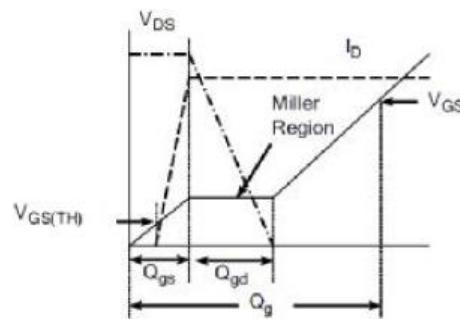


Figure 18. Gate Charge Waveform

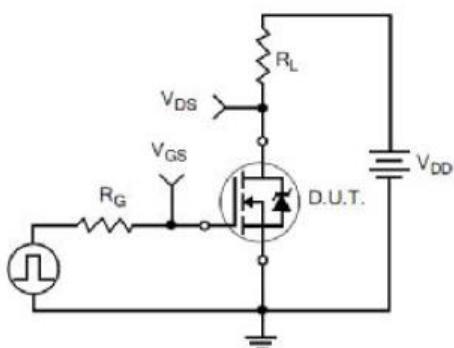


Figure 19. Resistive Switching Test Circuit

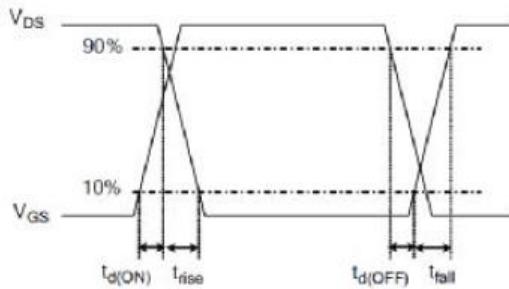


Figure 20. Resistive Switching Waveforms